Features

- High-performance, Low-power AVR® 8-bit Microcontroller
- Advanced RISC Architecture
 - 131 Powerful Instructions Most Single-clock Cycle Execution
 - 32 x 8 General Purpose Working Registers
 - Fully Static Operation
 - Up to 16 MIPS Throughput at 16 MHz
 - On-chip 2-cycle Multiplier
- Nonvolatile Program and Data Memories
 - 16K Bytes of In-System Self-Programmable Flash
 - Endurance: 10,000 Write/Erase Cycles

Optional Boot Code Section with Independent Lock Bits In-System Programming by On-chip Boot Program

True Read-While-Write Operation

- 512 Bytes EEPROM
 - Endurance: 100,000 Write/Erase Cycles
- 1K Byte Internal SRAM
- Programming Lock for Software Security
- JTAG (IEEE std. 1149.1 Compliant) Interface
 - Boundary-scan Capabilities According to the JTAG Standard
 - Extensive On-chip Debug Support
 - Programming of Flash, EEPROM, Fuses, and Lock Bits through the JTAG Interface
- Peripheral Features
 - Two 8-bit Timer/Counters with Separate Prescalers and Compare Modes
 - One 16-bit Timer/Counter with Separate Prescaler, Compare Mode, and Capture Mode
 - Real Time Counter with Separate Oscillator
 - Four PWM Channels
 - 8-channel, 10-bit ADC
 - 8 Single-ended Channels
 - 7 Differential Channels in TQFP Package Only
 - 2 Differential Channels with Programmable Gain at 1x, 10x, or 200x
 - Byte-oriented Two-wire Serial Interface
 - Programmable Serial USART
 - Master/Slave SPI Serial Interface
 - Programmable Watchdog Timer with Separate On-chip Oscillator
 - On-chip Analog Comparator
- Special Microcontroller Features
 - Power-on Reset and Programmable Brown-out Detection
 - Internal Calibrated RC Oscillator
 - External and Internal Interrupt Sources
 - Six Sleep Modes: Idle, ADC Noise Reduction, Power-save, Power-down, Standby and Extended Standby
- I/O and Packages
 - 32 Programmable I/O Lines
 - 40-pin PDIP, 44-lead TQFP, and 44-pad QFN/MLF
- Operating Voltages
 - 2.7 5.5V for ATmega16L
 - 4.5 5.5V for ATmega16
- Speed Grades
 - 0 8 MHz for ATmega16L
 - 0 16 MHz for ATmega16
- Power Consumption @ 1 MHz, 3V, and 25°C for ATmega16L
 - Active: 1.1 mA
 - Idle Mode: 0.35 mA
 - Power-down Mode: < 1 μA



8-bit **AVR**®
Microcontroller with 16K Bytes In-System
Programmable Flash

ATmega16 ATmega16L

Summary

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

2466NS-AVR-10/06

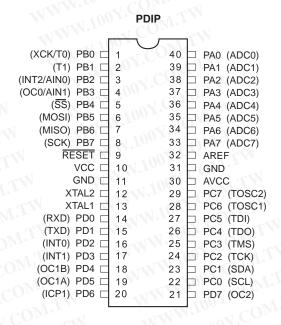


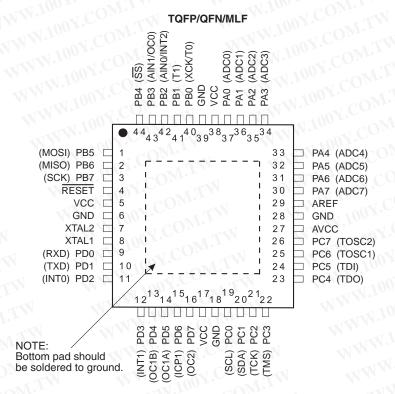
Note: This is a summary document. A complete document is available on our Web site at www.atmel.com.



Pin Configurations

Figure 1. Pinout ATmega16





勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Disclaimer

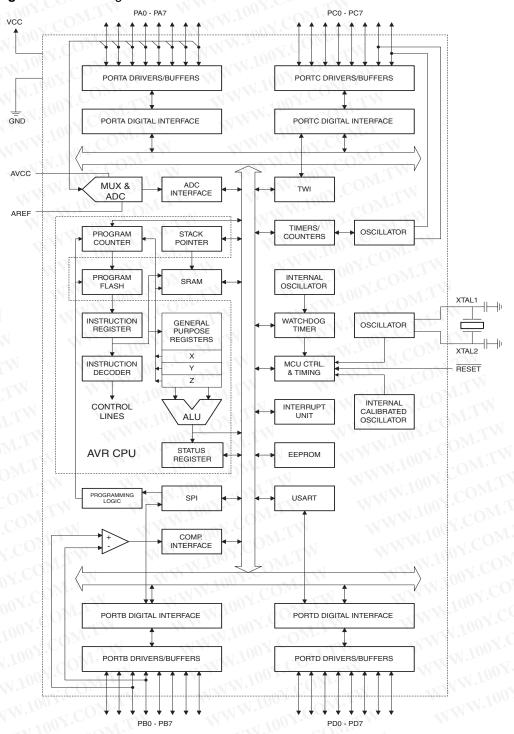
Typical values contained in this datasheet are based on simulations and characterization of other AVR microcontrollers manufactured on the same process technology. Min and Max values will be available after the device is characterized.

Overview

The ATmega16 is a low-power CMOS 8-bit microcontroller based on the AVR enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the ATmega16 achieves throughputs approaching 1 MIPS per MHz allowing the system designer to optimize power consumption versus processing speed.

Block Diagram

Figure 2. Block Diagram





勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw



The AVR core combines a rich instruction set with 32 general purpose working registers. All the 32 registers are directly connected to the Arithmetic Logic Unit (ALU), allowing two independent registers to be accessed in one single instruction executed in one clock cycle. The resulting architecture is more code efficient while achieving throughputs up to ten times faster than conventional CISC microcontrollers.

The ATmega16 provides the following features: 16K bytes of In-System Programmable Flash Program memory with Read-While-Write capabilities, 512 bytes EEPROM, 1K byte SRAM, 32 general purpose I/O lines, 32 general purpose working registers, a JTAG interface for Boundary-scan, On-chip Debugging support and programming, three flexible Timer/Counters with compare modes, Internal and External Interrupts, a serial programmable USART, a byte oriented Two-wire Serial Interface, an 8-channel, 10-bit ADC with optional differential input stage with programmable gain (TQFP package only), a programmable Watchdog Timer with Internal Oscillator, an SPI serial port, and six software selectable power saving modes. The Idle mode stops the CPU while allowing the USART, Two-wire interface, A/D Converter, SRAM, Timer/Counters, SPI port, and interrupt system to continue functioning. The Power-down mode saves the register contents but freezes the Oscillator, disabling all other chip functions until the next External Interrupt or Hardware Reset. In Power-save mode, the Asynchronous Timer continues to run, allowing the user to maintain a timer base while the rest of the device is sleeping. The ADC Noise Reduction mode stops the CPU and all I/O modules except Asynchronous Timer and ADC, to minimize switching noise during ADC conversions. In Standby mode, the crystal/resonator Oscillator is running while the rest of the device is sleeping. This allows very fast start-up combined with low-power consumption. In Extended Standby mode, both the main Oscillator and the Asynchronous Timer continue to run.

The device is manufactured using Atmel's high density nonvolatile memory technology. The On-chip ISP Flash allows the program memory to be reprogrammed in-system through an SPI serial interface, by a conventional nonvolatile memory programmer, or by an On-chip Boot program running on the AVR core. The boot program can use any interface to download the application program in the Application Flash memory. Software in the Boot Flash section will continue to run while the Application Flash section is updated, providing true Read-While-Write operation. By combining an 8-bit RISC CPU with In-System Self-Programmable Flash on a monolithic chip, the Atmel ATmega16 is a powerful microcontroller that provides a highly-flexible and cost-effective solution to many embedded control applications.

The ATmega16 AVR is supported with a full suite of program and system development tools including: C compilers, macro assemblers, program debugger/simulators, in-circuit emulators, and evaluation kits.

Pin Descriptions

VCC Digital supply voltage.

GND Ground.

Port A (PA7..PA0) Port A serves as the analog inputs to the A/D Converter.

Port A also serves as an 8-bit bi-directional I/O port, if the A/D Converter is not used. Port pins can provide internal pull-up resistors (selected for each bit). The Port A output buffers have symmetrical drive characteristics with both high sink and source capability. When pins PA0 to PA7 are used as inputs and are externally pulled low, they will source current if the internal pull-up resistors are activated. The Port A pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port B (PB7..PB0)

Port B is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port B output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port B pins that are externally pulled low will source current if the pull-up resistors are activated. The Port B pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port B also serves the functions of various special features of the ATmega16 as listed on page 56.

Port C (PC7..PC0)

Port C is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port C output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port C pins that are externally pulled low will source current if the pull-up resistors are activated. The Port C pins are tri-stated when a reset condition becomes active, even if the clock is not running. If the JTAG interface is enabled, the pull-up resistors on pins PC5(TDI), PC3(TMS) and PC2(TCK) will be activated even if a reset occurs.

Port C also serves the functions of the JTAG interface and other special features of the ATmega16 as listed on page 59.

Port D (PD7..PD0)

Port D is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port D output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port D pins that are externally pulled low will source current if the pull-up resistors are activated. The Port D pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port D also serves the functions of various special features of the ATmega16 as listed on page 61.

RESET

Reset Input. A low level on this pin for longer than the minimum pulse length will generate a reset, even if the clock is not running. The minimum pulse length is given in Table 15 on page 36. Shorter pulses are not guaranteed to generate a reset.

XTAL1

Input to the inverting Oscillator amplifier and input to the internal clock operating circuit.

XTAL2

Output from the inverting Oscillator amplifier.

AVCC

AVCC is the supply voltage pin for Port A and the A/D Converter. It should be externally connected to V_{CC} , even if the ADC is not used. If the ADC is used, it should be connected to V_{CC} , through a law page filter.

nected to V_{CC} through a low-pass filter.

AREF

AREF is the analog reference pin for the A/D Converter.

Resources

A comprehensive set of development tools, application notes and datasheets are available for download on http://www.atmel.com/avr.





勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www. 100y. com. tw

Register	· Sumn	nary			WW	® (1)	20 胜物			-83298787
Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
\$3F (\$5F)	SREG	A W	I/C	H	S	V	N	Z	С	7
\$3E (\$5E)	SPH		100-2	σM±1, ,	_		SP10	SP9	SP8	10
\$3D (\$5D)	SPL	SP7	SP6	SP5	SP4	SP3	SP2	SP1	SP0	10
\$3C (\$5C)	OCR0 GICR	INT1	0 Output Compai	INT2	- N	NAM.	To C	IVEEL	IVCE	83 46, 67
\$3B (\$5B) \$3A (\$5A)	GIFR	INTT	INTF0	INTF2	_		100=1.	IVSEL	IVCE _	68
\$39 (\$59)	TIMSK	OCIE2	TOIE2	TICIE1	OCIE1A	OCIE1B	TOIE1	OCIE0	TOIE0	83, 114, 132
\$38 (\$58)	TIFR	OCF2	TOV2	ICF1	OCF1A	OCF1B	TOV1	OCF0	TOV0	84, 115, 132
\$37 (\$57)	SPMCR	SPMIE	RWWSB	1.0-	RWWSRE	BLBSET	PGWRT	PGERS	SPMEN	250
\$36 (\$56)	TWCR	TWINT	TWEA	TWSTA	TWSTO	TWWC	TWEN	CON	TWIE	178
\$35 (\$55)	MCUCR	SM2	SE	SM1	SM0	ISC11	ISC10	ISC01	ISC00	30, 66
\$34 (\$54)	MCUCSR	JTD	ISC2	-1-CO	JTRF	WDRF	BORF	EXTRF	PORF	39, 67, 229
\$33 (\$53)	TCCR0	FOC0	WGM00	COM01	COM00	WGM01	CS02	CS01	CS00	81
\$32 (\$52)	TCNT0	Timer/Counter		C	7			W.Co.		83
\$31 ⁽¹⁾ (\$51) ⁽¹⁾	OSCCAL		oration Register	1110	OM:1	7	WW.1	100	11.2	28
W. A.	OCDR	On-Chip Debu		ADTOS		46115	DUD -	Dess	D0212	225
\$30 (\$50) \$2E (\$4E)	SFIOR TCCP1A	ADTS2	ADTS1	ADTS0	COMARO	ACME FOC1A	PUD FOC1R	PSR2	PSR10	55,86,133,199,21
\$2F (\$4F) \$2E (\$4E)	TCCR1A TCCR1B	COM1A1 ICNC1	COM1A0 ICES1	COM1B1	COM1B0 WGM13	FOC1A WGM12	FOC1B CS12	WGM11 CS11	WGM10 CS10	109 112
\$2D (\$4D)	TCNT1H		1 – Counter Regi	ster High Byte	VVGIVITS	WGW12	U312	CSII	C310	113
\$2C (\$4C)	TCNT1L		1 – Counter Regi	- 1	-OM-		-11	N.100	COMP	113
\$2B (\$4B)	OCR1AH			are Register A Hi	gh Byte	TW	MA	1007		113
\$2A (\$4A)	OCR1AL			are Register A Lo				W.Io.	COMP	113
\$29 (\$49)	OCR1BH	Timer/Counter	1 – Output Comp	are Register B Hi	gh Byte	TW	MA	- 100		113
\$28 (\$48)	OCR1BL	Timer/Counter	1 – Output Comp	are Register B Lo	w Byte	-41	17	W.	41 COM	113
\$27 (\$47)	ICR1H	Timer/Counter	1 - Input Capture	Register High By	/te	TIVE		100	11.	114
\$26 (\$46)	ICR1L	Timer/Counter	1 - Input Capture	Register Low By	te	Min			VI COR	114
\$25 (\$45)	TCCR2	FOC2	WGM20	COM21	COM20	WGM21	CS22	CS21	CS20	127
\$24 (\$44)	TCNT2	Timer/Counter			• J.C	Un	Ţ -		av. Co	129
\$23 (\$43)	OCR2		2 Output Compar	re Register	1100	· · · · ·			- c0	129
\$22 (\$42)	ASSR	CG		- T	-	AS2	TCN2UB	OCR2UB	TCR2UB	130
\$21 (\$41)	WDTCR	- UDCEI), \'= 	-	WDTOE	WDE	WDP2	WDP1	WDP0	41
\$20 ⁽²⁾ (\$40) ⁽²⁾	UBRRH	URSEL	UMSEL	UPM1	UPM0	USBS	UCSZ1	R[11:8] UCSZ0	UCPOL	165 164
\$1F (\$3F)	EEARH	UKSEL	UNSEL	OFWIT	OPIVIO _	U3B3	00321	-	EEAR8	17
\$1E (\$3E)	EEARL	EEPROM Add	ress Register Lov	w Byte	100				ELARO	17
\$1D (\$3D)	EEDR	EEPROM Data	7 Y 7 7	<u> </u>	M. T.	W.Co.	TW	MA	1007	17
\$1C (\$3C)	EECR	100 = 7	1112	-	-XI=N.10	EERIE	EEMWE	EEWE	EERE	- CO 17
\$1B (\$3B)	PORTA	PORTA7	PORTA6	PORTA5	PORTA4	PORTA3	PORTA2	PORTA1	PORTA0	64
\$1A (\$3A)	DDRA	DDA7	DDA6	DDA5	DDA4	DDA3	DDA2	DDA1	DDA0	64
\$19 (\$39)	PINA	PINA7	PINA6	PINA5	PINA4	PINA3	PINA2	PINA1	PINA0	64
\$18 (\$38)	PORTB	PORTB7	PORTB6	PORTB5	PORTB4	PORTB3	PORTB2	PORTB1	PORTB0	64
\$17 (\$37)	DDRB	DDB7	DDB6	DDB5	DDB4	DDB3	DDB2	DDB1	DDB0	64
\$16 (\$36)	PINB	PINB7	PINB6	PINB5	PINB4	PINB3	PINB2	PINB1	PINB0	64
\$15 (\$35)	PORTC	PORTC7	PORTC6	PORTC5	PORTC4	PORTC3	PORTC2	PORTC1	PORTC0	65
\$14 (\$34) \$12 (\$33)	DDRC	DDC7	DDC6	DDC5	DDC4	DDC3	DDC2	DDC1	DDC0	65
\$13 (\$33) \$12 (\$32)	PINC	PINC7 PORTD7	PINC6 PORTD6	PINC5 PORTD5	PINC4 PORTD4	PINC3 PORTD3	PINC2 PORTD2	PINC1 PORTD1	PINC0 PORTD0	65
\$12 (\$32) \$11 (\$31)	DDRD	DDD7	DDD6	DDD5	DDD4	DDD3	DDD2	DDD1	DDD0	65
\$10 (\$30)	PIND	PIND7	PIND6	PIND5	PIND4	PIND3	PIND2	PIND1	PIND0	65
\$0F (\$2F)	SPDR	SPI Data Reg	7.001.7	OM. I		- TAN 10		1		140
\$0E (\$2E)	SPSR	SPIF	WCOL		- <	(1/1/2)	OUX-COS	7-11	SPI2X	140
\$0D (\$2D)	SPCR	SPIE	SPE	DORD	MSTR	CPOL	СРНА	SPR1	SPR0	138
\$0C (\$2C)	UDR	USART I/O D	ata Register		N	MAL	1007	TW	- N	161
\$0B (\$2B)	UCSRA	RXC	TXC	UDRE	FE	DOR	PE,	U2X	MPCM	162
\$0A (\$2A)	UCSRB	RXCIE	TXCIE	UDRIE	RXEN	TXEN	UCSZ2	RXB8	TXB8	163
\$09 (\$29)	UBRRL	USART Baud	Rate Register Lo	w Byte	- 15J	TAX IN	N. T	COMP	N	165
\$08 (\$28)	ACSR	ACD	ACBG	ACO	ACI	ACIE	ACIC	ACIS1	ACIS0	200
\$07 (\$27)	ADMUX	REFS1	REFS0	ADLAR	MUX4	MUX3	MUX2	MUX1	MUX0	215
\$06 (\$26)	ADCSRA	ADEN	ADSC	ADATE	ADIF	ADIE	ADPS2	ADPS1	ADPS0	217
\$05 (\$25)	ADCH		gister High Byte	MY.CO.	TYP:	W	N ' Ann	Y.U.	TW	218
\$04 (\$24)	ADCL	· · · · · · · · · · · · · · · · · · ·	gister Low Byte	Pogiater	M. T.	*	ANN LOO	- 27 COM	- X X	218
\$03 (\$23)	TWDR	i wo-wire Seria	al Interface Data I	Register		1/1	11.			180

TENTEN 1 NOV. COM.TW

WWW.100Y.C

										5 (
Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
\$01 (\$21)	TWSR	TWS7	TWS6	TWS5	TWS4	TWS3	4 CDy	TWPS1	TWPS0	179
\$00 (\$20)	TWBR	Two-wire Seria	al Interface Bit Ra	te Register	14	10	0.1	V:7.		178

Notes:

- 1. When the OCDEN Fuse is unprogrammed, the OSCCAL Register is always accessed on this address. Refer to the debugger specific documentation for details on how to use the OCDR Register.
- Refer to the USART description for details on how to access UBRRH and UCSRC.
- 3. For compatibility with future devices, reserved bits should be written to zero if accessed. Reserved I/O memory addresses should never be written.
- 4. Some of the Status Flags are cleared by writing a logical one to them. Note that the CBI and SBI instructions will operate on all bits in the I/O Register, writing a one back into any flag read as set, thus clearing the flag. The CBI and SBI instructions work with registers \$00 to \$1F only.





勝 特 力 材 料 886-3-5753170 ■ 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Instruction Set Summary

Mnemonics	Operands	Description	Operation	Flags	#Clocks
ARITHMETIC AND	LOGIC INSTRUCTION	ons .	MM. OUT.	1	•
ADD	Rd, Rr	Add two Registers	Rd ← Rd + Rr	Z,C,N,V,H	1
ADC	Rd, Rr	Add with Carry two Registers	$Rd \leftarrow Rd + Rr + C$	Z,C,N,V,H	1
ADIW	Rdl,K	Add Immediate to Word	Rdh:Rdl ← Rdh:Rdl + K	Z,C,N,V,S	2
SUB	Rd, Rr	Subtract two Registers	Rd ← Rd - Rr	Z,C,N,V,H	1
SUBI	Rd, K	Subtract Constant from Register	Rd ← Rd - K	Z,C,N,V,H	1
SBC	Rd, Rr	Subtract with Carry two Registers	Rd ← Rd - Rr - C	Z,C,N,V,H	1
SBCI	Rd, K	Subtract with Carry Constant from Reg.	Rd ← Rd - K - C	Z,C,N,V,H	1
SBIW	Rdl,K	Subtract Immediate from Word	Rdh:Rdl ← Rdh:Rdl - K	Z,C,N,V,S	2
AND	Rd, Rr	Logical AND Registers	$Rd \leftarrow Rd \bullet Rr$	Z,N,V	1
ANDI	Rd, K	Logical AND Register and Constant	$Rd \leftarrow Rd \bullet K$	Z,N,V	1
OR	Rd, Rr	Logical OR Registers	$Rd \leftarrow Rd \vee Rr$	Z,N,V	1
ORI	Rd, K	Logical OR Register and Constant	$Rd \leftarrow Rd \vee K$	Z,N,V	1
EOR	Rd, Rr	Exclusive OR Registers	$Rd \leftarrow Rd \oplus Rr$	Z,N,V	1
COM	Rd	One's Complement	Rd ← \$FF – Rd	Z,C,N,V	1
NEG	Rd	Two's Complement	Rd ← \$00 – Rd	Z,C,N,V,H	1
SBR	Rd,K	Set Bit(s) in Register	$Rd \leftarrow Rd \vee K$	Z,N,V	1
CBR	Rd,K	Clear Bit(s) in Register	$Rd \leftarrow Rd \bullet (\$FF - K)$	Z,N,V	1
INC.	Rd	Increment	$Rd \leftarrow Rd + 1$	Z,N,V	1
DEC	Rd	Decrement	Rd ← Rd – 1	Z,N,V	1
TST	Rd	Test for Zero or Minus	$Rd \leftarrow Rd \bullet Rd$	Z,N,V	1
CLR	Rd	Clear Register	$Rd \leftarrow Rd \oplus Rd$	Z,N,V	1
SER	Rd	Set Register	Rd ← \$FF	None	1
MUL	Rd, Rr	Multiply Unsigned	R1:R0 ← Rd x Rr	Z,C	2
MULS	Rd, Rr	Multiply Signed	R1:R0 ← Rd x Rr	Z,C	2
MULSU	Rd, Rr	Multiply Signed with Unsigned	R1:R0 ← Rd x Rr	Z,C	2
FMUL	Rd, Rr	Fractional Multiply Unsigned	$R1:R0 \leftarrow (Rd \times Rr) << 1$	Z,C	2
FMULS	Rd, Rr	Fractional Multiply Signed	$R1:R0 \leftarrow (Rd \times Rr) << 1$	Z,C	2
FMULSU	Rd, Rr	Fractional Multiply Signed with Unsigned	R1:R0 ← (Rd x Rr) << 1	Z,C	2
BRANCH INSTRUC		31.11		COMP	
RJMP	l k	Relative Jump	PC ← PC + k + 1	None	2
IJMP	-x1 100 3	Indirect Jump to (Z)	PC ← Z	None	2
JMP	k J	Direct Jump	PC ← k	None	3
RCALL	k 100	Relative Subroutine Call	PC ← PC + k + 1	None	3
ICALL	WAY TO	Indirect Call to (Z)	PC ← Z	None	3
CALL	k XX	Direct Subroutine Call	PC ← k	None	4
RET	1 11 11	Subroutine Return	PC ← STACK	None	4
RETI	111.10	Interrupt Return	PC ← STACK	W 1 <1 C	4
CPSE	Rd,Rr	Compare, Skip if Equal	if $(Rd = Rr) PC \leftarrow PC + 2 \text{ or } 3$	None	1/2/3
CP	Rd,Rr	Compare	Rd – Rr	Z, N,V,C,H	1.00
CPC	Rd,Rr	Compare with Carry	Rd – Rr – C	Z, N,V,C,H	001
CPI	Rd,K	Compare Register with Immediate	Rd – K	Z, N,V,C,H	1
SBRC	Rr, b	Skip if Bit in Register Cleared	if $(Rr(b)=0) PC \leftarrow PC + 2 \text{ or } 3$	None	1/2/3
SBRS	Rr, b	Skip if Bit in Register is Set	if $(Rr(b)=1)$ PC \leftarrow PC + 2 or 3	None	1/2/3
SBIC	P, b	Skip if Bit in I/O Register Cleared	if $(P(b)=0)$ PC \leftarrow PC + 2 or 3	None	1/2/3
SBIS	P, b	Skip if Bit in I/O Register Gleared Skip if Bit in I/O Register is Set	if $(P(b)=0)$ PC \leftarrow PC + 2 or 3	None	1/2/3
BRBS	s, k	Branch if Status Flag Set	if (SREG(s) = 1) then PC←PC+k + 1	None	1/2/3
BRBC	s, k	Branch if Status Flag Cleared	if (SREG(s) = 1) then PC←PC+k + 1 if (SREG(s) = 0) then PC←PC+k + 1	None	1/2
BREQ	k	Branch if Equal	if $(Z = 1)$ then $PC \leftarrow PC + k + 1$	None	1/2
BRNE	k	Branch if Not Equal	if $(Z = 1)$ then $PC \leftarrow PC + k + 1$ if $(Z = 0)$ then $PC \leftarrow PC + k + 1$	None	1/2
BRCS	k	Branch if Carry Set		None	1/2
		Branch if Carry Set Branch if Carry Cleared	if (C = 1) then PC \leftarrow PC + k + 1 if (C = 0) then PC \leftarrow PC + k + 1		A 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
BRCC	k		if $(C = 0)$ then $PC \leftarrow PC + k + 1$	None	1/2
BRSH	k	Branch if Same or Higher Branch if Lower	if $(C = 0)$ then $PC \leftarrow PC + k + 1$	None	1/2
BRLO	k		if (C = 1) then PC \leftarrow PC + k + 1	None	1/2
BRMI	k	Branch if Minus	if (N = 1) then PC \leftarrow PC + k + 1	None	1/2
BRPL	k	Branch if Outstands Freed Circuit	if (N = 0) then PC ← PC + k + 1	None	1/2
BRGE	k	Branch if Greater or Equal, Signed	if (N ⊕ V= 0) then PC ← PC + k + 1	None	1/2
BRLT	k	Branch if Less Than Zero, Signed	if (N ⊕ V= 1) then PC ← PC + k + 1	None	1/2
BRHS	k	Branch if Half Carry Flag Set	if (H = 1) then PC \leftarrow PC + k + 1	None	1/2
BRHC	k	Branch if Half Carry Flag Cleared	if (H = 0) then PC \leftarrow PC + k + 1	None	1/2
BRTS	k	Branch if T Flag Set	if (T = 1) then PC \leftarrow PC + k + 1	None	1/2
BRTC	k	Branch if T Flag Cleared	if $(T = 0)$ then $PC \leftarrow PC + k + 1$	None	1/2
BRVS	k	Branch if Overflow Flag is Set	if (V = 1) then PC ← PC + k + 1	None	1/2
BRVC	k	Branch if Overflow Flag is Cleared	if $(V = 0)$ then $PC \leftarrow PC + k + 1$	None	1/2

TENTEN INNY.COM.TW

WWW.100Y.C

Mnemonics	Operands	Description	Operation	Flags	#Clocks
BRIE	k	Branch if Interrupt Enabled	if (I = 1) then PC ← PC + k + 1	None	1/2
BRID	k	Branch if Interrupt Disabled	if (I = 0) then PC ← PC + k + 1	None	1/2
DATA TRANSFER	INSTRUCTIONS	N W. CO. TV	WW. COX.CO TW	T	
MOV	Rd, Rr	Move Between Registers	Rd ← Rr	None	1
MOVW	Rd, Rr	Copy Register Word	Rd+1:Rd ← Rr+1:Rr	None	1
LDI	Rd, K	Load Immediate	$Rd \leftarrow K$	None	1
LD LD	Rd, X	Load Indirect and Post Inc.	$Rd \leftarrow (X)$	None	2
LD	Rd, X+ Rd, - X	Load Indirect and Post-Inc. Load Indirect and Pre-Dec.	$Rd \leftarrow (X), X \leftarrow X + 1$ $X \leftarrow X - 1, Rd \leftarrow (X)$	None None	2
LD	Rd, Y	Load Indirect	$Rd \leftarrow (Y)$	None	2
LD	Rd, Y+	Load Indirect and Post-Inc.	$Rd \leftarrow (Y), Y \leftarrow Y + 1$	None	2
LD	Rd, - Y	Load Indirect and Pre-Dec.	$Y \leftarrow Y - 1$, $Rd \leftarrow (Y)$	None	2
LDD	Rd,Y+q	Load Indirect with Displacement	$Rd \leftarrow (Y + q)$	None	2
LD	Rd, Z	Load Indirect	Rd ← (Z)	None	2
LD	Rd, Z+	Load Indirect and Post-Inc.	$Rd \leftarrow (Z), Z \leftarrow Z+1$	None	2
LD	Rd, -Z	Load Indirect and Pre-Dec.	$Z \leftarrow Z - 1$, $Rd \leftarrow (Z)$	None	2
LDD	Rd, Z+q	Load Indirect with Displacement	$Rd \leftarrow (Z + q)$	None	2
LDS	Rd, k	Load Direct from SRAM	Rd ← (k)	None	2
ST	X, Rr	Store Indirect	$(X) \leftarrow Rr$	None	2
ST	X+, Rr	Store Indirect and Post-Inc.	$(X) \leftarrow Rr, X \leftarrow X + 1$	None	2
ST	- X, Rr	Store Indirect and Pre-Dec.	$X \leftarrow X - 1, (X) \leftarrow Rr$	None	2
ST	Y, Rr	Store Indirect	(Y) ← Rr	None	2
ST	Y+, Rr	Store Indirect and Post-Inc.	$(Y) \leftarrow Rr, Y \leftarrow Y + 1$	None	2
STD	- Y, Rr	Store Indirect with Displacement	$Y \leftarrow Y - 1, (Y) \leftarrow Rr$	None	2 2
ST	Y+q,Rr Z, Rr	Store Indirect with Displacement Store Indirect	$(Y + q) \leftarrow Rr$ $(Z) \leftarrow Rr$	None None	2
ST	Z+, Rr	Store Indirect Store Indirect and Post-Inc.	$(Z) \leftarrow RI$ $(Z) \leftarrow Rr, Z \leftarrow Z + 1$	None	2
ST	-Z, Rr	Store Indirect and Pre-Dec.	$Z \leftarrow Z - 1, (Z) \leftarrow Rr$	None	2
STD	Z+q,Rr	Store Indirect with Displacement	$(Z+q) \leftarrow Rr$	None	2
STS	k, Rr	Store Direct to SRAM	(k) ← Rr	None	2
LPM	1.30 -1 CC	Load Program Memory	$R0 \leftarrow (Z)$	None	3
LPM	Rd, Z	Load Program Memory	$Rd \leftarrow (Z)$	None	3
LPM	Rd, Z+	Load Program Memory and Post-Inc	$Rd \leftarrow (Z), Z \leftarrow Z+1$	None	3
SPM	-11 100 r.	Store Program Memory	(Z) ← R1:R0	None	-1-
IN	Rd, P	In Port	Rd ← P	None	1
OUT	P, Rr	Out Port	P ← Rr	None	1
PUSH	Rr	Push Register on Stack	STACK ← Rr	None	2
POP	Rd	Pop Register from Stack	Rd ← STACK	None	2
BIT AND BIT-TEST		Lauris van	1000	NI LIVE	The same
SBI	P,b	Set Bit in I/O Register	I/O(P,b) ← 1	None	2
LSL	P,b Rd	Clear Bit in I/O Register Logical Shift Left	$I/O(P,b) \leftarrow 0$ $Rd(n+1) \leftarrow Rd(n), Rd(0) \leftarrow 0$	None Z,C,N,V	1
LSR	Rd	Logical Shift Right	$Rd(n) \leftarrow Rd(n+1), Rd(0) \leftarrow 0$ $Rd(n) \leftarrow Rd(n+1), Rd(7) \leftarrow 0$	Z,C,N,V	1
ROL	Rd	Rotate Left Through Carry	$Rd(0) \leftarrow C, Rd(n+1) \leftarrow Rd(n), C \leftarrow Rd(7)$	Z,C,N,V	0 1 4
ROR	Rd	Rotate Right Through Carry	$Rd(7) \leftarrow C, Rd(n) \leftarrow Rd(n+1), C \leftarrow Rd(0)$	Z,C,N,V	01
ASR	Rd	Arithmetic Shift Right	$Rd(n) \leftarrow Rd(n+1), n=06$	Z,C,N,V	1 7
SWAP	Rd	Swap Nibbles	Rd(30)←Rd(74),Rd(74)←Rd(30)	None	1
BSET	S	Flag Set	SREG(s) ← 1	SREG(s)	1
BCLR	S	Flag Clear	$SREG(s) \leftarrow 0$	SREG(s)	1
BST	Rr, b	Bit Store from Register to T	$T \leftarrow Rr(b)$	T	1
BLD	Rd, b	Bit load from T to Register	$Rd(b) \leftarrow T$	None	ro
SEC	111	Set Carry	C ← 1	С	1 1
CLC	,	Clear Carry	C ← 0	С	1.0
SEN	T)	Set Negative Flag	N ← 1	N	1
CLN		Clear Negative Flag	N ← 0	N 7	1 1 C
SEZ CLZ	+	Set Zero Flag Clear Zero Flag	Z ← 1 Z ← 0	Z	104
SEI	+	Global Interrupt Enable	Z ← U I ← 1	1	1100
CLI	+	Global Interrupt Disable	1←1	-41	1.0
SES	1	Set Signed Test Flag	S ← 1	S	100
CLS	1	Clear Signed Test Flag	S ← 0	N S	1 00
SEV		Set Twos Complement Overflow.	V ← 1	V	1
CLV		Clear Twos Complement Overflow	V ← 0	V V	1
SET	1	Set T in SREG	T ← 1	T	1
CLT		Clear T in SREG	T ← 0	TVIT	1
SEH		Set Half Carry Flag in SREG	H←1	Н	1





Mnemonics	Operands	Description	Operation	Flags	#Clocks
CLH	- TX	Clear Half Carry Flag in SREG	H ← 0	Н	1
MCU CONTROL	INSTRUCTIONS	1100 ON:1	TAL TOO		
NOP	V X	No Operation	W. ONE	None	1
SLEEP		Sleep	(see specific descr. for Sleep function)	None	1
WDR		Watchdog Reset	(see specific descr. for WDR/timer)	None	1
BREAK	. 1	Break	For On-Chip Debug Only	None	N/A

W.100Y.COM.TW

· ATmega16(L)

特力材料886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Ordering Information

Speed (MHz)	Power Supply	Ordering Code	Package	Operation Range
COM.TW	MMM.100A.CO	ATmega16L-8AC ATmega16L-8PC ATmega16L-8MC	44A 40P6 44M1	Commercial (0°C to 70°C)
DY.COM.TW DOY.COM.TW 100Y.COM.TW	2.7 - 5.5V	ATmega16L-8AI ATmega16L-8AU ⁽¹⁾ ATmega16L-8PI ATmega16L-8PU ⁽¹⁾ ATmega16L-8MI ATmega16L-8MU ⁽¹⁾	44A 44A 40P6 40P6 44M1 44M1	Industrial (-40°C to 85°C)
W.100X.COM.T	MAM.TO	ATmega16-16AC ATmega16-16PC ATmega16-16MC	44A 40P6 44M1	Commercial (0°C to 70°C)
100 / 100 / COM	4.5 - 5.5V	ATmega16-16AI ATmega16-16AU ⁽¹⁾ ATmega16-16PI ATmega16-16PU ⁽¹⁾ ATmega16-16MI ATmega16-16MU ⁽¹⁾	44A 44A 40P6 40P6 44M1 44M1	Industrial (-40°C to 85°C)

1. Pb-free packaging alternative, complies to the European Directive for Restriction of Hazardous Substances (RoHS direc-Note: WWW.100Y.CON tive). Also Halide free and fully Green. WWW.100Y.COM.TW

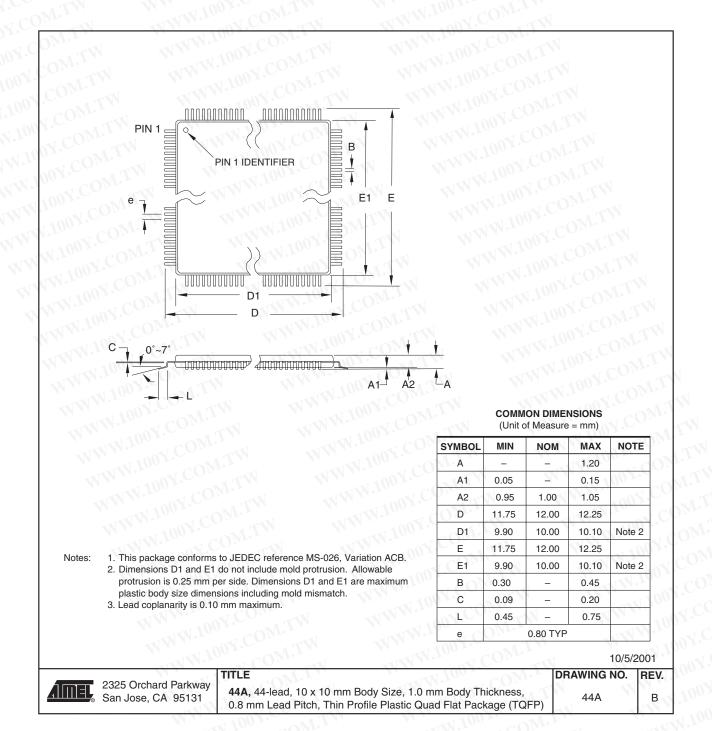
	WW.100X.COM.TW WW.100X.COM.TW WWW.100X.
	Package Type
44A	44-lead, Thin (1.0 mm) Plastic Gull Wing Quad Flat Package (TQFP)
40P6	40-pin, 0.600" Wide, Plastic Dual Inline Package (PDIP)
44M1	44-pad, 7 x 7 x 1.0 mm body, lead pitch 0.50 mm, Quad Flat No-Lead/Micro Lead Frame Package (QFN/MLF)





Packaging Information

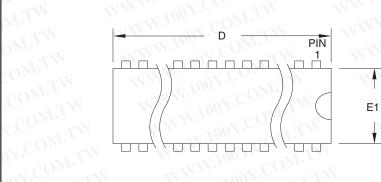
44A

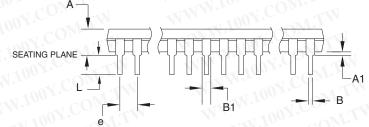


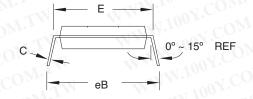
ATmega16(L) ■

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787

40P6







Notes:

- 1. This package conforms to JEDEC reference MS-011, Variation AC.
- Dimensions D and E1 do not include mold Flash or Protrusion. Mold Flash or Protrusion shall not exceed 0.25 mm (0.010").

COMMON DIMENSIONS (Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
Α		MA	4.826	Co.
A1	0.381	- STAN	1.70	ST CC
D	52.070	A	52.578	Note 2
E	15.240	17/1	15.875	01.0
E1	13.462	71/	13.970	Note 2
В	0.356		0.559	00
B1	1.041	- //	1.651	1003
V _L	3.048	_ <	3.556	- 100
C	0.203	_	0.381	1.10
eB	15.494	_	17.526	W.10
е	TW	2.540 TYF		- 11

09/28/01

<u>AIMEL</u>

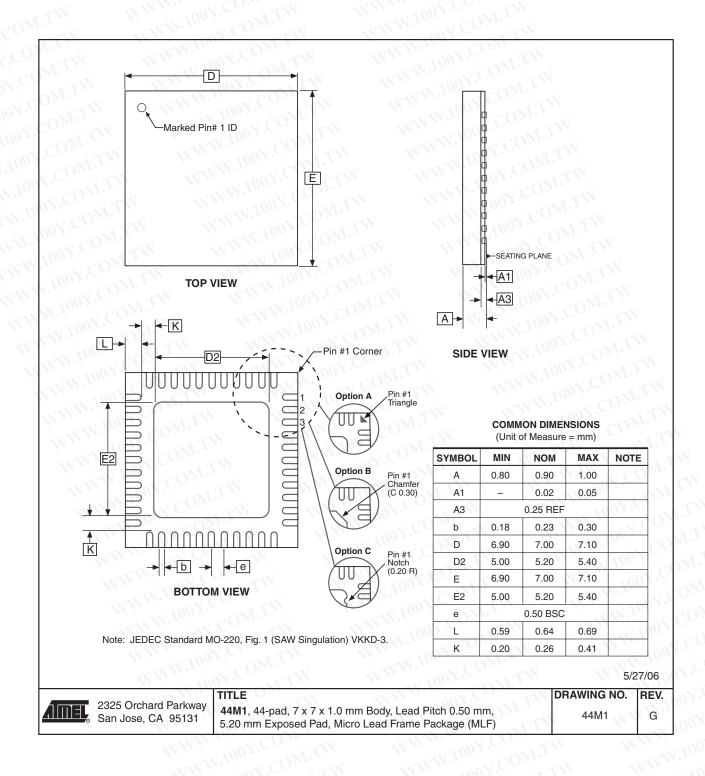
2325 Orchard Parkway San Jose, CA 95131 TITLE
40P6, 40-lead (0.600"/15.24 mm Wide) Plastic Dual Inline Package (PDIP)

DRAWING NO. REV. 40P6 B

<u>AIMEL</u>



44M1



ATmega16(L)

Errata

The revision letter in this section refers to the revision of the ATmega16 device.

ATmega16(L) Rev. M

- First Analog Comparator conversion may be delayed
- · Interrupts may be lost when writing the timer registers in the asynchronous timer
- IDCODE masks data from TDI input

1. First Analog Comparator conversion may be delayed

If the device is powered by a slow rising V_{CC} , the first Analog Comparator conversion will take longer than expected on some devices.

Problem Fix/Workaround

When the device has been powered or reset, disable then enable the Analog Comparator before the first conversion.

2. Interrupts may be lost when writing the timer registers in the asynchronous timer

If one of the timer registers which is synchronized to the asynchronous timer2 clock is written in the cycle before a overflow interrupt occurs, the interrupt may be lost.

Problem Fix/Workaround

Always check that the Timer2 Timer/Counter register, TCNT2, does not have the value 0xFF before writing the Timer2 Control Register, TCCR2, or Output Compare Register, OCR2

3. IDCODE masks data from TDI input

The JTAG instruction IDCODE is not working correctly. Data to succeeding devices are replaced by all-ones during Update-DR.

Problem Fix / Workaround

- If ATmega16 is the only device in the scan chain, the problem is not visible.
- Select the Device ID Register of the ATmega16 by issuing the IDCODE instruction or by entering the Test-Logic-Reset state of the TAP controller to read out the contents of its Device ID Register and possibly data from succeeding devices of the scan chain. Issue the BYPASS instruction to the ATmega16 while reading the Device ID Registers of preceding devices of the boundary scan chain.
- If the Device IDs of all devices in the boundary scan chain must be captured simultaneously, the ATmega16 must be the fist device in the chain.

ATmega16(L) Rev. L

- First Analog Comparator conversion may be delayed
- Interrupts may be lost when writing the timer registers in the asynchronous timer
- IDCODE masks data from TDI input

1. First Analog Comparator conversion may be delayed

If the device is powered by a slow rising V_{CC} , the first Analog Comparator conversion will take longer than expected on some devices.

Problem Fix/Workaround

When the device has been powered or reset, disable then enable the Analog Comparator before the first conversion.

2. Interrupts may be lost when writing the timer registers in the asynchronous timer





If one of the timer registers which is synchronized to the asynchronous timer2 clock is written in the cycle before a overflow interrupt occurs, the interrupt may be lost.

Problem Fix/Workaround

Always check that the Timer2 Timer/Counter register, TCNT2, does not have the value 0xFF before writing the Timer2 Control Register, TCCR2, or Output Compare Register, OCR2

3. IDCODE masks data from TDI input

The JTAG instruction IDCODE is not working correctly. Data to succeeding devices are replaced by all-ones during Update-DR.

Problem Fix / Workaround

- If ATmega16 is the only device in the scan chain, the problem is not visible.
- Select the Device ID Register of the ATmega16 by issuing the IDCODE instruction or by entering the Test-Logic-Reset state of the TAP controller to read out the contents of its Device ID Register and possibly data from succeeding devices of the scan chain. Issue the BYPASS instruction to the ATmega16 while reading the Device ID Registers of preceding devices of the boundary scan chain.
- If the Device IDs of all devices in the boundary scan chain must be captured simultaneously, the ATmega16 must be the fist device in the chain.

ATmega16(L) Rev. K

- First Analog Comparator conversion may be delayed
- · Interrupts may be lost when writing the timer registers in the asynchronous timer
- IDCODE masks data from TDI input

1. First Analog Comparator conversion may be delayed

If the device is powered by a slow rising $V_{\rm CC}$, the first Analog Comparator conversion will take longer than expected on some devices.

Problem Fix/Workaround

When the device has been powered or reset, disable then enable the Analog Comparator before the first conversion.

2. Interrupts may be lost when writing the timer registers in the asynchronous timer

If one of the timer registers which is synchronized to the asynchronous timer2 clock is written in the cycle before a overflow interrupt occurs, the interrupt may be lost.

Problem Fix/Workaround

Always check that the Timer2 Timer/Counter register, TCNT2, does not have the value 0xFF before writing the Timer2 Control Register, TCCR2, or Output Compare Register, OCR2

3. IDCODE masks data from TDI input

The JTAG instruction IDCODE is not working correctly. Data to succeeding devices are replaced by all-ones during Update-DR.

Problem Fix / Workaround

- If ATmega16 is the only device in the scan chain, the problem is not visible.
- Select the Device ID Register of the ATmega16 by issuing the IDCODE instruction or by entering the Test-Logic-Reset state of the TAP controller to read out the contents of its Device ID Register and possibly data from

succeeding devices of the scan chain. Issue the BYPASS instruction to the ATmega16 while reading the Device ID Registers of preceding devices of the boundary scan chain.

 If the Device IDs of all devices in the boundary scan chain must be captured simultaneously, the ATmega16 must be the fist device in the chain.

ATmega16(L) Rev. J

- First Analog Comparator conversion may be delayed
- · Interrupts may be lost when writing the timer registers in the asynchronous timer
- IDCODE masks data from TDI input

1. First Analog Comparator conversion may be delayed

If the device is powered by a slow rising $V_{\rm CC}$, the first Analog Comparator conversion will take longer than expected on some devices.

Problem Fix/Workaround

When the device has been powered or reset, disable then enable the Analog Comparator before the first conversion.

2. Interrupts may be lost when writing the timer registers in the asynchronous timer

If one of the timer registers which is synchronized to the asynchronous timer2 clock is written in the cycle before a overflow interrupt occurs, the interrupt may be lost.

Problem Fix/Workaround

Always check that the Timer2 Timer/Counter register, TCNT2, does not have the value 0xFF before writing the Timer2 Control Register, TCCR2, or Output Compare Register, OCR2

3. IDCODE masks data from TDI input

The JTAG instruction IDCODE is not working correctly. Data to succeeding devices are replaced by all-ones during Update-DR.

Problem Fix / Workaround

- If ATmega16 is the only device in the scan chain, the problem is not visible.
- Select the Device ID Register of the ATmega16 by issuing the IDCODE instruction or by entering the Test-Logic-Reset state of the TAP controller to read out the contents of its Device ID Register and possibly data from succeeding devices of the scan chain. Issue the BYPASS instruction to the ATmega16 while reading the Device ID Registers of preceding devices of the boundary scan chain.
- If the Device IDs of all devices in the boundary scan chain must be captured simultaneously, the ATmega16 must be the fist device in the chain.

ATmega16(L) Rev. I

- First Analog Comparator conversion may be delayed
- Interrupts may be lost when writing the timer registers in the asynchronous timer
- IDCODE masks data from TDI input

1. First Analog Comparator conversion may be delayed

If the device is powered by a slow rising V_{CC} , the first Analog Comparator conversion will take longer than expected on some devices.

Problem Fix/Workaround

When the device has been powered or reset, disable then enable theAnalog Comparator before the first conversion.





2. Interrupts may be lost when writing the timer registers in the asynchronous timer

If one of the timer registers which is synchronized to the asynchronous timer2 clock is written in the cycle before a overflow interrupt occurs, the interrupt may be lost.

Problem Fix/Workaround

Always check that the Timer2 Timer/Counter register, TCNT2, does not have the value 0xFF before writing the Timer2 Control Register, TCCR2, or Output Compare Register, OCR2

3. IDCODE masks data from TDI input

The JTAG instruction IDCODE is not working correctly. Data to succeeding devices are replaced by all-ones during Update-DR.

Problem Fix / Workaround

- If ATmega16 is the only device in the scan chain, the problem is not visible.
- Select the Device ID Register of the ATmega16 by issuing the IDCODE instruction or by entering the Test-Logic-Reset state of the TAP controller to read out the contents of its Device ID Register and possibly data from succeeding devices of the scan chain. Issue the BYPASS instruction to the ATmega16 while reading the Device ID Registers of preceding devices of the boundary scan chain.
- If the Device IDs of all devices in the boundary scan chain must be captured simultaneously, the ATmega16 must be the fist device in the chain.

ATmega16(L) Rev. H

- First Analog Comparator conversion may be delayed
- . Interrupts may be lost when writing the timer registers in the asynchronous timer
- IDCODE masks data from TDI input

1. First Analog Comparator conversion may be delayed

If the device is powered by a slow rising $V_{\rm CC}$, the first Analog Comparator conversion will take longer than expected on some devices.

Problem Fix/Workaround

When the device has been powered or reset, disable then enable theAnalog Comparator before the first conversion.

2. Interrupts may be lost when writing the timer registers in the asynchronous timer

If one of the timer registers which is synchronized to the asynchronous timer2 clock is written in the cycle before a overflow interrupt occurs, the interrupt may be lost.

Problem Fix/Workaround

Always check that the Timer2 Timer/Counter register, TCNT2, does not have the value 0xFF before writing the Timer2 Control Register, TCCR2, or Output Compare Register, OCR2

3. IDCODE masks data from TDI input

The JTAG instruction IDCODE is not working correctly. Data to succeeding devices are replaced by all-ones during Update-DR.

Problem Fix / Workaround

If ATmega16 is the only device in the scan chain, the problem is not visible.

ATmega16(L)

- Select the Device ID Register of the ATmega16 by issuing the IDCODE instruction or by entering the Test-Logic-Reset state of the TAP controller to read out the contents of its Device ID Register and possibly data from succeeding devices of the scan chain. Issue the BYPASS instruction to the ATmega16 while reading the Device ID Registers of preceding devices of the boundary scan chain.
 - If the Device IDs of all devices in the boundary scan chain must be captured simultaneously, the ATmega16 must be the fist device in the chain.



勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787

WWW.100Y.COM.TW



Datasheet Revision History

Please note that the referring page numbers in this section are referred to this document. The referring revision in this section are referring to the document revision.

Rev. 2466N-10/06

- Updated "Timer/Counter Oscillator" on page 31.
- 2. Updated "Fast PWM Mode" on page 102.
- 3. Updated Table 38 on page 83, Table 40 on page 84, Table 45 on page 112, Table 47 on page 113, Table 50 on page 129 and Table 52 on page 130.
- 4. Updated C code example in "USART Initialization" on page 150.
- 5. Updated "Errata" on page 343.

Rev. 2466M-04/06

- 1. Updated typos.
- 2. Updated "Serial Peripheral Interface SPI" on page 136.
- 3. Updated Table 86 on page 222, Table 116 on page 279 ,Table 121 on page 298 and Table 122 on page 300.

Rev. 2466L-06/05

- 1. Updated note in "Bit Rate Generator Unit" on page 179.
- 2. Updated values for V_{INT} in "ADC Characteristics" on page 300.
- 3. Updated "Serial Programming Instruction set" on page 279.
- 4. Updated USART init C-code example in "USART" on page 145.

Rev. 2466K-04/05

- 1. Updated "Ordering Information" on page 11.
- 2. MLF-package alternative changed to "Quad Flat No-Lead/Micro Lead Frame Package QFN/MLF".
- 3. Updated "Electrical Characteristics" on page 294.

Rev. 2466J-10/04

Updated "Ordering Information" on page 11.

Rev. 2466I-10/04

- Removed references to analog ground.
- Updated Table 7 on page 28, Table 15 on page 38, Table 16 on page 42, Table 81 on page 211, Table 116 on page 279, and Table 119 on page 296.
- 3. Updated "Pinout ATmega16" on page 2.
- 4. Updated features in "Analog to Digital Converter" on page 205.
- 5. Updated "Version" on page 230.
- 6. Updated "Calibration Byte" on page 264.

- 7. Added "Page Size" on page 265.
- Rev. 2466H-12/03
- 1. Updated "Calibrated Internal RC Oscillator" on page 29.
- Rev. 2466G-10/03
- 1. Removed "Preliminary" from the datasheet.
- 2. Changed ICP to ICP1 in the datasheet.
- 3. Updated "JTAG Interface and On-chip Debug System" on page 36.
- 4. Updated assembly and C code examples in "Watchdog Timer Control Register WDTCR" on page 43.
- 5. Updated Figure 46 on page 103.
- 6. Updated Table 15 on page 38, Table 82 on page 218 and Table 115 on page 279.
- 7. Updated "Test Access Port TAP" on page 223 regarding JTAGEN.
- 8. Updated description for the JTD bit on page 232.
- 9. Added note 2 to Figure 126 on page 255.
- 10. Added a note regarding JTAGEN fuse to Table 105 on page 263.
- 11. Updated Absolute Maximum Ratings* and DC Characteristics in "Electrical Characteristics" on page 294.
- 12. Updated "ATmega16 Typical Characteristics" on page 302.
- 13. Fixed typo for 16 MHz QFN/MLF package in "Ordering Information" on page 11.
- 14. Added a proposal for solving problems regarding the JTAG instruction IDCODE in "Errata" on page 15.
- Rev. 2466F-02/03
- 1. Added note about masking out unused bits when reading the Program Counter in "Stack Pointer" on page 12.
- 2. Added Chip Erase as a first step in "Programming the Flash" on page 291 and "Programming the EEPROM" on page 292.
- 3. Added the section "Unconnected pins" on page 55.
- 4. Added tips on how to disable the OCD system in "On-chip Debug System" on page 34.
- Removed reference to the "Multi-purpose Oscillator" application note and "32 kHz Crystal Oscillator" application note, which do not exist.
- 6. Added information about PWM symmetry for Timer0 and Timer2.





- 7. Added note in "Filling the Temporary Buffer (Page Loading)" on page 256 about writing to the EEPROM during an SPM Page Load.
- 8. Removed ADHSM completely.
- 9. Added Table 73, "TWI Bit Rate Prescaler," on page 183 to describe the TWPS bits in the "TWI Status Register TWSR" on page 182.
- 10. Added section "Default Clock Source" on page 25.
- Added note about frequency variation when using an external clock. Note added in "External Clock" on page 31. An extra row and a note added in Table 118 on page 296.
- 12. Various minor TWI corrections.
- 13. Added "Power Consumption" data in "Features" on page 1.
- 14. Added section "EEPROM Write During Power-down Sleep Mode" on page 22.
- 15. Added note about Differential Mode with Auto Triggering in "Prescaling and Conversion Timing" on page 208.
- 16. Added updated "Packaging Information" on page 12.
- Rev. 2466E-10/02
- Updated "DC Characteristics" on page 294.
- Rev. 2466D-09/02
- Changed all Flash write/erase cycles from 1,000 to 10,000.
- 2. Updated the following tables: Table 4 on page 26, Table 15 on page 38, Table 42 on page 85, Table 45 on page 112, Table 46 on page 112, Table 59 on page 144, Table 67 on page 168, Table 90 on page 237, Table 102 on page 261, "DC Characteristics" on page 294, Table 119 on page 296, Table 121 on page 298, and Table 122 on page 300.
- 3. Updated "Errata" on page 15.
- Rev. 2466C-03/02
- 1. Updated typical EEPROM programming time, Table 1 on page 20
- 2. Updated typical start-up time in the following tables:

Table 3 on page 25, Table 5 on page 27, Table 6 on page 28, Table 8 on page 29, Table 9 on page 29, and Table 10 on page 30.

- 3. Updated Table 17 on page 43 with typical WDT Time-out.
- 4. Added Some Preliminary Test Limits and Characterization Data

Removed some of the TBD's in the following tables and pages:

Table 15 on page 38, Table 16 on page 42, Table 116 on page 272 (table removed in document review #D), "Electrical Characteristics" on page 294, Table 119 on page 296, Table 121 on page 298, and Table 122 on page 300.

5. Updated TWI Chapter.

ATmega16(L)

Added the note at the end of the "Bit Rate Generator Unit" on page 179.

- Corrected description of ADSC bit in "ADC Control and Status Register A ADCSRA" on page 220.
- 7. Improved description on how to do a polarity check of the ADC doff results in "ADC Conversion Result" on page 217.
- 8. Added JTAG version number for rev. H in Table 87 on page 230.
- 9. Added not regarding OCDEN Fuse below Table 105 on page 263.
- 10. Updated Programming Figures:

Figure 127 on page 265 and Figure 136 on page 277 are updated to also reflect that AVCC must be connected during Programming mode. Figure 131 on page 273 added to illustrate how to program the fuses.

- 11. Added a note regarding usage of the "PROG_PAGELOAD (\$6)" on page 283 and "PROG_PAGEREAD (\$7)" on page 283.
- **12.** Removed alternative algorthhm for leaving JTAG Programming mode. See "Leaving Programming Mode" on page 291.
- 13. Added Calibrated RC Oscillator characterization curves in section "ATmega16 Typical Characteristics" on page 302.
- 14. Corrected ordering code for QFN/MLF package (16MHz) in "Ordering Information" on page 11.
- 15. Corrected Table 90, "Scan Signals for the Oscillators(1)(2)(3)," on page 237.





Atmel Corporation

2325 Orchard Parkway San Jose, CA 95131, USA Tel: 1(408) 441-0311 Fax: 1(408) 487-2600

Regional Headquarters

Europe

Atmel Sarl Route des Arsenaux 41 Case Postale 80 CH-1705 Fribourg Switzerland

Tel: (41) 26-426-5555 Fax: (41) 26-426-5500

Asia

Room 1219 Chinachem Golden Plaza 77 Mody Road Tsimshatsui East Kowloon Hong Kong

Tel: (852) 2721-9778 Fax: (852) 2722-1369

Japan

9F, Tonetsu Shinkawa Bldg. 1-24-8 Shinkawa Chuo-ku, Tokyo 104-0033 Japan

Tel: (81) 3-3523-3551 Fax: (81) 3-3523-7581

Atmel Operations

Memory

2325 Orchard Parkway San Jose, CA 95131, USA Tel: 1(408) 441-0311 Fax: 1(408) 436-4314

Microcontrollers

2325 Orchard Parkway San Jose, CA 95131, USA Tel: 1(408) 441-0311 Fax: 1(408) 436-4314

La Chantrerie BP 70602 44306 Nantes Cedex 3, France Tel: (33) 2-40-18-18-18 Fax: (33) 2-40-18-19-60

ASIC/ASSP/Smart Cards

Zone Industrielle 13106 Rousset Cedex, France Tel: (33) 4-42-53-60-00

Fax: (33) 4-42-53-60-01

1150 East Cheyenne Mtn. Blvd. Colorado Springs, CO 80906, USA

Tel: 1(719) 576-3300 Fax: 1(719) 540-1759

Scottish Enterprise Technology Park Maxwell Building East Kilbride G75 0QR, Scotland

Tel: (44) 1355-803-000 Fax: (44) 1355-242-743

RF/Automotive

Theresienstrasse 2 Postfach 3535 74025 Heilbronn, Germany Tel: (49) 71-31-67-0

Fax: (49) 71-31-67-2340

1150 East Cheyenne Mtn. Blvd. Colorado Springs, CO 80906, USA

Tel: 1(719) 576-3300 Fax: 1(719) 540-1759

Biometrics/Imaging/Hi-Rel MPU/ High Speed Converters/RF Datacom

Avenue de Rochepleine

BP 123

38521 Saint-Egreve Cedex, France

Tel: (33) 4-76-58-30-00 Fax: (33) 4-76-58-34-80

Literature Requests www.atmel.com/literature

Disclaimer: The information in this document is provided in connection with Atmel products. No license, express or implied, by estoppel or otherwise, to any intellectual property right is granted by this document or in connection with the sale of Atmel products. EXCEPT AS SET FORTH IN ATMEL'S TERMS AND CONDITIONS OF SALE LOCATED ON ATMEL'S WEB SITE, ATMEL ASSUMES NO LIABILITY WHATSOEVER AND DISCLAIMS ANY EXPRESS, IMPLIED OR STATUTORY WARRANTY RELATING TO ITS PRODUCTS INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTY OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT. IN NO EVENT SHALL ATMEL BE LIABLE FOR ANY DIRECT, INDIRECT, CONSEQUENTIAL, PUNITIVE, SPECIAL OR INCIDENTAL DAMAGES (INCLUDING, WITHOUT LIMITATION, DAMAGES FOR LOSS OF PROFITS, BUSINESS INTERRUPTION, OR LOSS OF INFORMATION) ARISING OUT OF THE USE OR INABILITY TO USE THIS DOCUMENT, EVEN IF ATMEL HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. Atmel makes no representations or warranties with respect to the accuracy or completeness of the contents of this document and reserves the right to make changes to specifications and product descriptions at any time without notice. Atmel does not make any commitment to update the information contained herein. Unless specifically provided otherwise, Atmel products are not suitable for, and shall not be used in, automotive applications. Atmel's products are not intended, authorized, or warranted for use as components in applications intended to support or sustain life.

© 2006 Atmel Corporation. All rights reserved. Atmel[®], logo and combinations thereof, Everywhere You Are[®], AVR[®], AVR Studio[®], and others, are registered trademarks or trademarks of Atmel Corporation or its subsidiaries. Other terms and product names may be trademarks of others.